



SPECIFICATION FOR APPROVAL

Customer				
Customer P/N				
Drawing No				
Quantity	Х	Pcs.	Date	2024/10/9
Pulse P/N		AMRU00040420SeriesB1		

Automotive Grade Inductor

Halogen Free RoHS Compliant REACH Compliant Lead Free Solders AEC-Q200

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Drawn by	Checked by	Approved by
Ryan Tsai	Wayne Wu	Mark Chung





Revisions

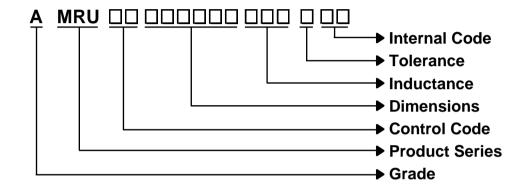
Rev	Description	Date	Approved by	Checked by	Drawn by
Α	Initial release	2024/10/9	Mark Chung	Wayne Wu	Ryan Tsai





AEC-Q200

- 1 Scope This specification applies to large current and low loss SMD power inductor.
- 2 Part numbering

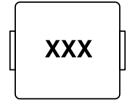


3 Temperature rating

Operating Temperature: - 40°C to 125°C.

Storage Temperature: (on tape & reel): -20°C to +40°C; 75% RH max.

4 Marking



Marking: 1R0

5 Standard testing condition

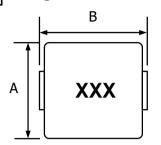
	Unless otherwise specified	In case of doubt
Temperature	Ordinary Temperature(15 to 35°C)	20 to 30°C
Humidity	Ordinary Humidity(25 to 85% RH)	50 to 80 %RH

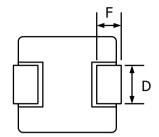




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6 Configuration and dimensions







Dimensions in mm

Туре	040420
Α	4.2 ± 0.25
В	4.7 ± 0.25
С	1.8 ± 0.2
D	2.0 ± 0.3
F	1.0 ± 0.3

Size code	Net weight(grms)
040420	0.18(typ.)

7 Electrical characteristics

Part number	Inductance (uH)	Tolerance (±%)	Test Freq.	Irms(A) Typ.	Isat(A) Typ.	RDC(mΩ) Max.(Typ.)	Marking
AMRU00040420R47MB1	0.47	20	100kHz,0.5V	7	10	14(12)	R47
AMRU000404201R0MB1	1	20	100kHz,0.5V	4.5	7	27(24)	1R0
AMRU000404201R5MB1	1.5	20	100kHz,0.5V	4	6	46(38)	1R5
AMRU000404202R2MB1	2.2	20	100kHz,0.5V	3	5	55(50)	2R2
AMRU000404203R3MB1	3.3	20	100kHz,0.5V	2.7	4.2	83(75)	3R3
AMRU000404204R7MB1	4.7	20	100kHz,0.5V	2.2	3.5	105(95)	4R7
AMRU00040420100MB1	10	20	100kHz,0.5V	1.5	2.3	250(225)	100

Note:

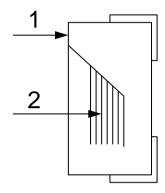
- 1.Operating temperature range -40°C to 125°C.
- 2.Isat for inductance drop 30% from its value without current.
- 3.Irms for a 40°C temperature rise from 25°C ambient.
- 4.The part temperature (ambient + temp rise) should not exceed 125°C under worst case operating conditions. Circuit design 125°C under worst case operating conditions. Component placement, PWB trace size and thickness, airflow and other cooling provisions all affect the part temperature. Part temperature should be verified in the end application.
- 5. Absolute maximum voltage 30V DC. (Based on test method, it may not the sameunder different application, it is recommended to verify first.)

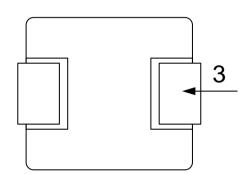




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8 AMRU00040420 Series 8.1 Construction





8.2 Material list

Item	Part	Description	
1 Magnetic core		Magnetic metal powder	
2	Coil	Enameled copper wire	
3	Terminals	Copper based terminal	





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9 Reliability test items

		_
1-1	Mechanical pe	rformance
1-1.	IVICCIIAIIICAI DE	HUHHHAHL

No	Item	Specification	Test Method
1-1-1	Board Flex	The forces applied on the right	Refer to AEC-Q200-005
		conditions must not damage	Test device shall be soldered on the substrate
		the terminal electrode and the	Substrate Dimension: 100x40x1.6mm
		ferrite	Deflection: 2.0mm
			Keeping Time: 60sec
1-1-2	Resistance to Soldering Heat	Appearance: No damage	Refer to MIL-STD-202 Method 210
		Inductance change shall be	Pre-heating: 150°C, 1min
		within ±10%.	Solder Composition: Sn/Ag3.0/Cu0.5(Pb-Free)
			Solder Temperature: 260±5°C
			Immersion Time: 10±1sec
1-1-3	Solder ability	The electrodes shall be at	Refer to J-STD-002
		least 95% covered with new	Pre-heating: 150°C, 1min
		solder coating	Solder Composition: Sn/Ag3.0/Cu0.5(Pb-Free)
			Solder Temperature: 245±5°C(Pb-Free)
			Immersion Time: 4±1sec
1-1-4	Terminal Strength Test	Appearance: No damage	Refer AEC-Q200-006
			Soldered on PCB for testing as fig.
			Force : 1.8kg
			Keeping Time: 60 seconds.
1-1-5	Resistance to Solvent	There must be no change in	Refer to MIL-STD-202 Method 215
		appearance or obliteration of	Inductors must withstand 6 mimutes of alcohol or water.
		marking	Sample Size : 15 pcs
1-1-6	Vibration	Appearance: No damage	Refer MIL-STD-202 Method 204
		Inductance change shall be	Vibration waveform: Sine waveform
		within ±10%.	Vibration frequency: 10Hz to 2000Hz
			Vibration acceleration: 5g
			Sweep rate: 0.764386otcave/minute
			Duration of test: 12 cycles each of 3 orientations,
			20 minutes for each cycle
			Vibration axes: X, Y & Z

1-2. Environmental performance

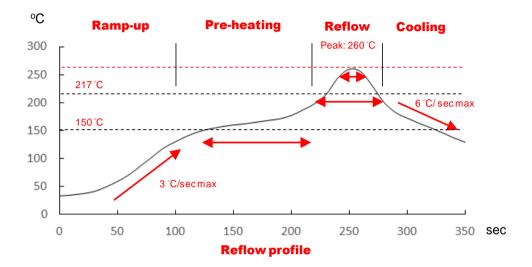
No	Item	Specification	Test Method
1-2-1	Temperature Cycle	Appearance: No damage	Refer to JESD Method JA-104
		Inductance change shall be	Total cycles: 1000 cycles
		within±20%	Temperature Cycling Test Conditions : -40 to +125 °C
			-40°C Soak Mode Condition: 30 minutes
			125°C Soak Mode Condition: 30 minutes
			Measured after exposure in the room condition for 24hrs
1-2-2	Biased Humidity Resistance		Refer to MIL-STD-202 Method 103
			Temperature: 85±2°C
			Relative Humidity:85% / Time: 1000hrs
			Measured after exposure in the room condition for 24hrs
1-2-3	High		Refer to MIL-STD-202 Method 108
	Temperature Exposure		Temperature: 125±3°C / Relative Humidity: 0%
	(Storage)		Applied Current: Rated Current /Time: 1000hrs
			Measured after exposure in the room condition for 24hrs
1-2-4	Operational Life		Refer to MIL-PRF-27
			Temperature: 85±3°C
			Applied Current : Rated Current
			Time: 1000hrs
			Measured after exposure in the room condition for 24hrs





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10 Recommended IR reflow profile



Lead-Free(LF) Refer to J-STD-020C

ltem	Ramp-up	Pre-heating	Reflow	Peak Temp.	Cooling
Temp. scope	R.T. ~150 °C	150 °C~200 °C	217 °C	260±5 °C	Peak Temp. 150 °C
Time spec	-	60~180 sec	60~150 sec	20~40 sec	-
Time result	-	75~100 sec	90~120 sec	20~35 sec	-

Note:

- 1. IR reflow times: within 3 times.
- 2. Nitrogen adopted is recommended while in IR reflow.



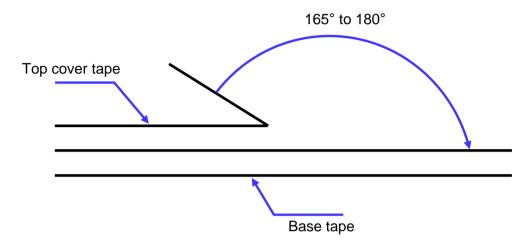


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11.1 Packaging- cover tape

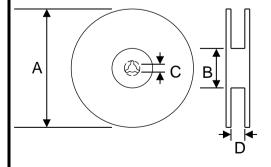
The force for tearing off cover tape is 10 to 130 grams.



11.2 Packaging quantity

Туре	Pcs/Reel
040420	2000

11.3 Reel dimensions



Dimensions in mm

Type	Α	В	С	D
040420	330	100	13	13

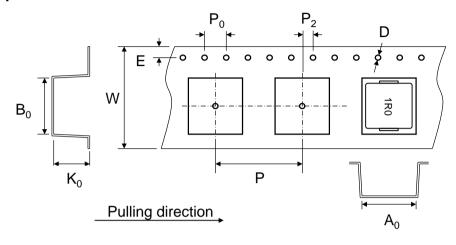




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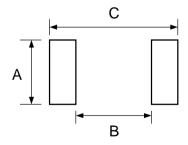
11 Packaging

11.4 Tape dimensions in mm



Туре	A_0	B_0	K ₀	D	Е	W	Р	P_0	P ₂
040420	4.5	5.1	2.4	1.55	1.75	12	8	4	2

12 Recommended pattern



Dimensions in mm

Туре	Α	В	С
040420	2.5	2.2	5.2

13 Note

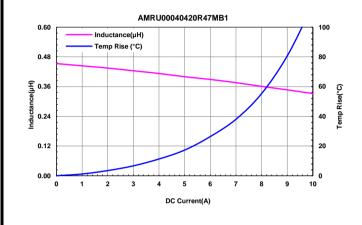
- 1. Please make sure that your product has been evaluated and confirmed against your specifications when our product is mounted to your product.
- 2. Don't design/mount any components in contact with this product
- 3. The moisture sensitivity level (MSL) of products is classified as level 1.
- 4. Shelf life: 1 years from the date of shipment.

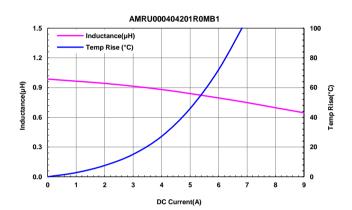


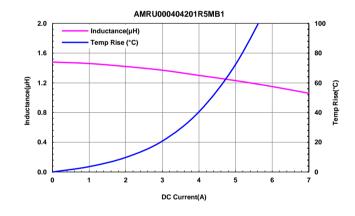


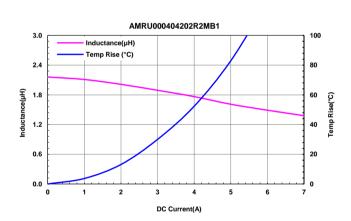
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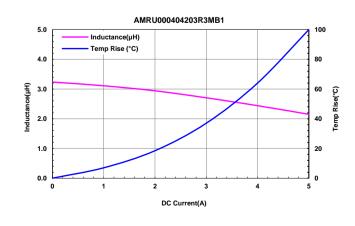
14 Graph:

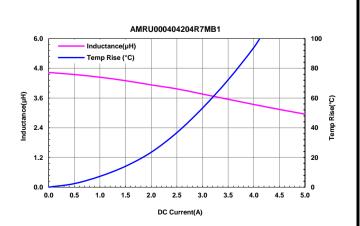
















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